

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.



FCPF400N60 N 沟道 SuperFET[®] II MOSFET 600 V、10 A、400 mΩ

特性

- 650 V @ T_J = 150°C
- ・ 典型值 R_{DS(on)} = 350 mΩ
- 超低栅极电荷 (典型值 Q_a = 28 nC)
- 低有效输出电容 (典型值 C_{oss(eff.)}= 90 pF)
- 100% 经过雪崩测试
- 符合 RoHS 标准

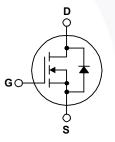
应用

- LCD / LED / PDP 电视照明
- 太阳能逆变器
- AC-DC 电源



SuperFET[®] II MOSFET 是飞兆半导体新一代利用电荷平衡技术 实现出色低导通电阻和更低栅极电荷性能的高压超级结 (SJ) MOSFET 系列产品。这项技术专用于最小化导通损耗并提供卓越 的开关性能、dv/dt 额定值和更高雪崩能量。因此, SuperFET MOSFET 非常适合开关电源应用,如功率因数校正 (PFC)、服务 器 / 电信电源、平板电视电源、ATX 电源及工业电源应用。





绝对最大额定值 Tc=25°C 除非另有说明。

符号	参数			FCPF400N60	单位
V _{DSS}	漏极一源极电压	600	V		
V _{GSS}	栅极一源极电压	- DC		±20	- V
		- AC	(f > 1 Hz)	±30	
I _D	漏极电流	- 连续 (T _C = 25°C)		10*	A
		- 连续 (T _C = 100°C)		6.3*	
DM	漏极电流	- 脉冲	(说明1)	30*	Α
AS	单脉冲雪崩能量 (说明 2)		211.6	mJ	
AR	雪崩电流		(说明1)	2.3	Α
AR	重复雪崩能量(说明		(说明1)	1.06	mJ
dv/dt	MOSFET dv/dt			100	V/ns
	二极管恢复 dv/dt 峰值 (说明 3)			20	
P _D	-1 +7	(T _C = 25°C)		31	W
	功耗	- 降低至 25°C 以上		0.25	W/°C
Г _Ј , Т _{STG}	工作和存储温度范围			-55 至 +150	°C
ΓL	用于焊接的最大引线温度,距离外壳 1/8",持续 5 秒			300	°C

*漏极电流受限于最大结温 热性能

符号 参数 FCPF400N60 单位 R_{0JC} 结至外壳热阻最大值 4.0 °C/W R_{0JA} 结至环境热阻最大值 62.5 °C/W

2014年2月

器件	编号	顶标	封装	包装方法	卷尺寸		带宽	ž,	数量
FCPF4		FCPF400N60			不适用		不适用	<u> 50</u> 个	
电气特性	$T_{c} = 25^{\circ}C$	除非另有说明。	L		_			1	
<u>)</u> (1911) 符号		<u>参数</u>		测试条件		最小值	典型值	最大值	单位
关断特性									
BV _{DSS}	漏极一源极击穿电压			V_{GS} = 0 V, I _D = 10 mA, T _J = 25°C		600	-	-	v
				V_{GS} = 0 V, I _D = 10 mA, T _J = 150°C		650	-	-	· ·
ΔBV _{DSS} /ΔT _J	击穿电压温度系数			I _D =10 mA,参考条件为 25°C		-	0.6	-	V/°C
BV _{DS}	漏源极雪	崩击穿电压		V _{GS} = 0 V, I _D = 10 A		-	700	-	V
「「「「」」の「「」」の「「」」の「「」」の「「」」の「」」の「」」の「」」の		压漏极电流	V _{DS} = 480 V, V _{GS} = 0 V		-	-	1	μA	
DSS	令伽似电	压调饭电加		V _{DS} = 480 V, T _C = 125		-	-	10	μΛ
I _{GSS}	栅极 - 体流	栅极 - 体漏电流		$V_{GS} = \pm 20 V, V_{DS} = 0 V$		-	-	±100	nA
导通特性									
V _{GS(th)}	栅极阈值电压			V _{GS} = V _{DS} , I _D = 250 μA		2.5	-	3.5	V
R _{DS(on)}	漏极至源极静态导通电阻			V _{GS} = 10 V, I _D = 5 A		-	0.35	0.40	Ω
9 _{FS}	正向跨导			V _{DS} = 20 V, I _D = 5 A		-	11	-	S
动态特性									
C _{iss}	输入电容	7				-	1180	1580	pF
C _{oss}	输出电容			─ V _{DS} = 25 V, V _{GS} = 0 V, _ f = 1 MHz		-	860	1144	pF
C _{rss}	反向传输				-	43	54	pF	
C _{oss}	输出电容			V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz		-	22	-	pF
C _{oss(eff.)}	有效输出电容			V _{DS} = 0 V 至 480 V, V _{GS} = 0 V		-	90	-	pF
Q _{g(tot)}	10 V 的栅	V 的栅极电荷总量		V _{DS} = 380 V, I _D = 5 A,		-	28	38	nC
Q _{gs}	栅极 - 源	极栅极电荷		V _{GS} = 10 V (说明 4)		-	5	-	nC
Q _{gd}	栅极 - 漏	极 " 米勒 " 电荷				-	10	-	nC
ESR	等效串联	等效串联电阻		f = 1 MHz		-	1	-	Ω
开关特性									
t _{d(on)}	导通延迟时间					-	13	37	ns
t _r	开通上升	时间	V _{DD} = 380 V, I _D = 5 A, V _{GS} = 10 V, R _G = 4.7 Ω		7-	7	24	ns	
t _{d(off)}	关断延迟				2	/ - ·	43	95	ns
t _f	关断下降时间			(说明 4)		-	6	21	ns
漏极 - 源极			1						
S	漏极 - 源极二极管最大正向连续电流					-	- >	10	Α
SM	漏极 - 源极二极管最大正向脉冲电流					-	-	30	Α
V _{SD}		极二极管正向电压		V _{GS} = 0 V, I _{SD} = 5 A		-	-	1.2	V
rr	反向恢复			V _{GS} = 0 V, I _{SD} = 5 A,		-	240		ns
Q _{rr}	反向恢复		V _{GS} = 0 V, I _{SD} = 3 Α, dI _F /dt = 100 Α/μs		-	2.7		μC	

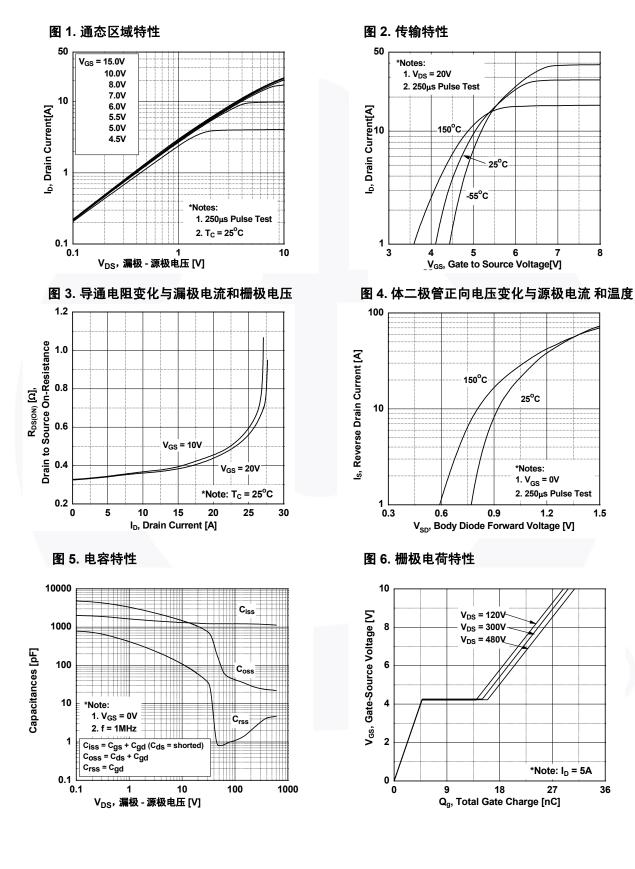
1. 重复额定值: 脉冲宽度受限于最大结温。

2. I_{AS} = 2.3 A, V_{DD} = 50 V, R_G = 25 Ω, 启动 T_J = 25°C。

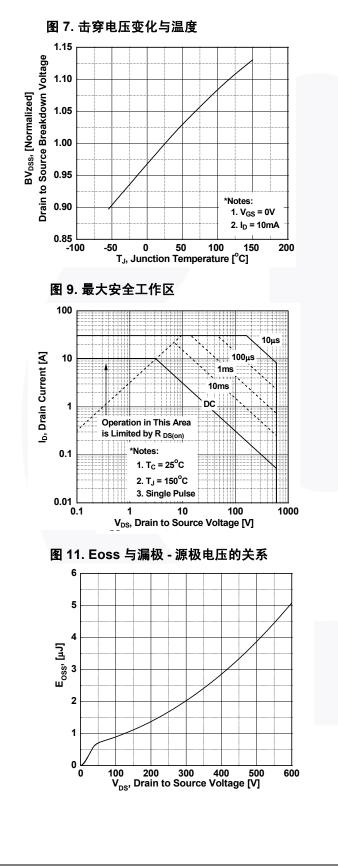
3. $I_{SD} \le 5 \text{ A}$, $di/dt \le 200 \text{ A}/\mu s$, $V_{DD} \le BV_{DSS}$, 启动 $T_J = 25^{\circ}C_{\circ}$

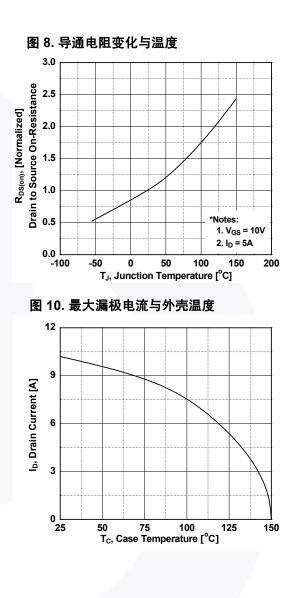
FCPF400N60 — N 沟道 SuperFET[®] II MOSFET

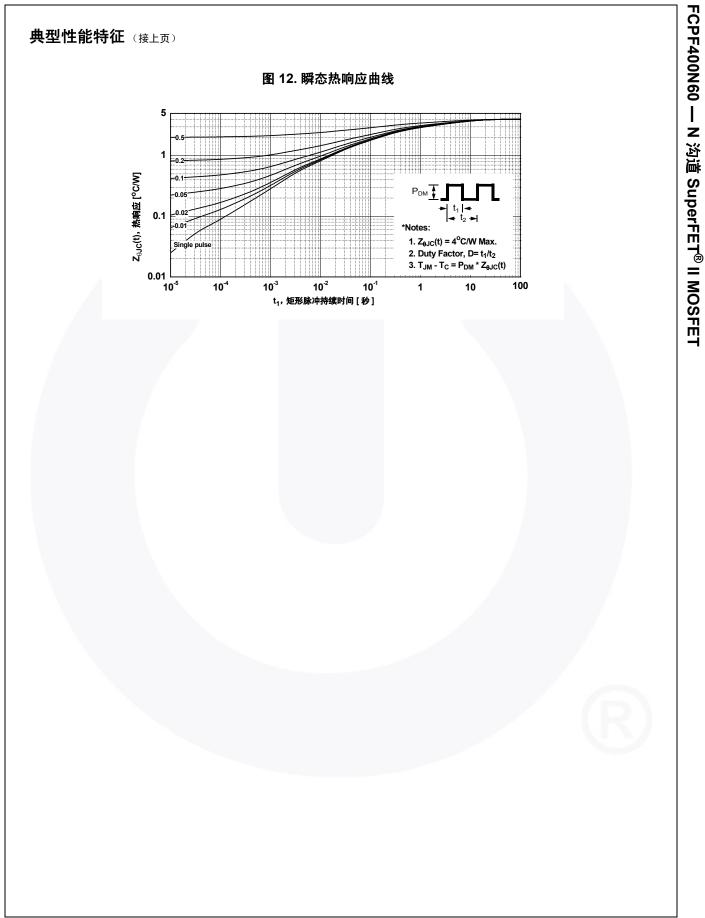
典型性能特征



典型性能特征 (接上页)

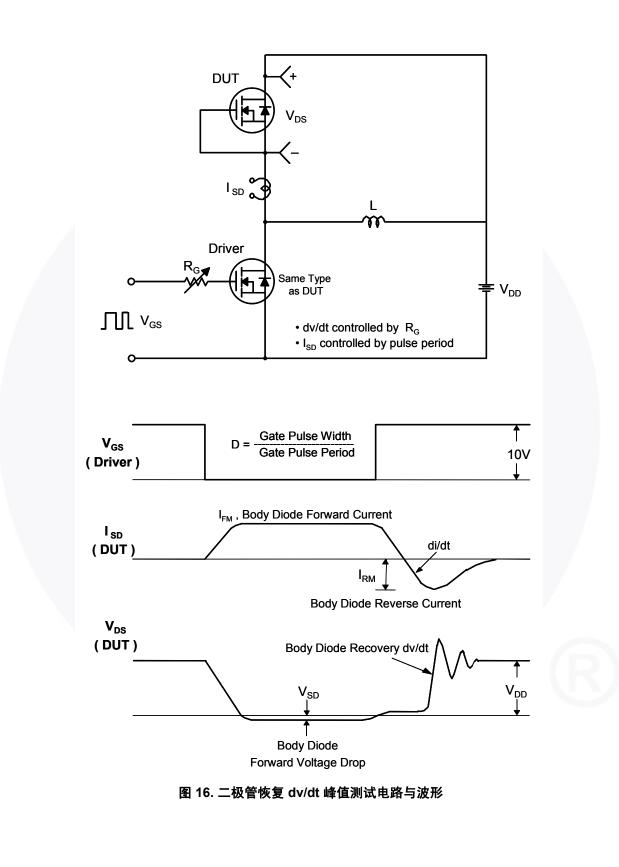


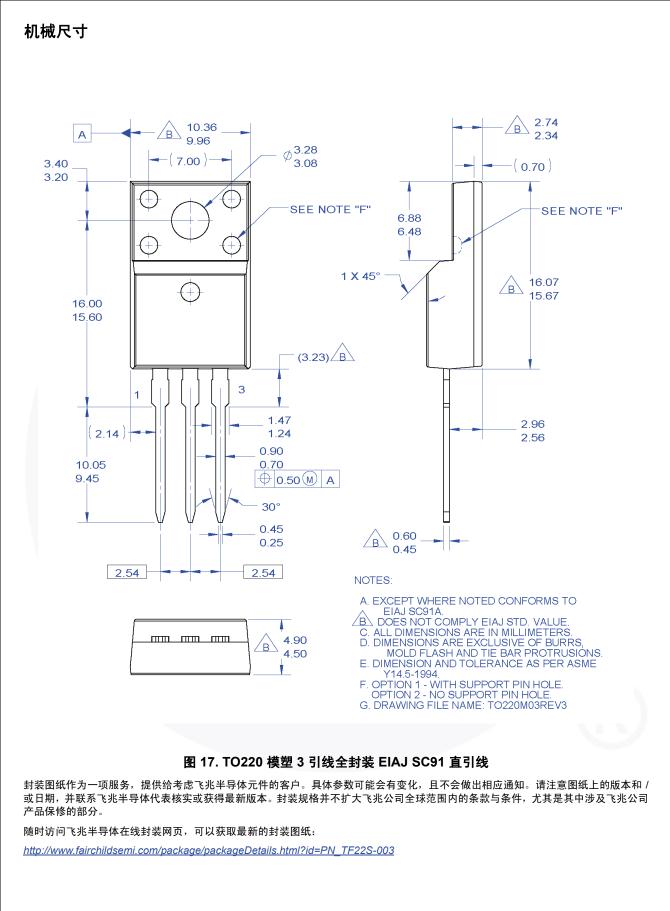




 V_{GS} ≷ֿ™ Q_g F V_{DS} Q_{gd} Q_{gs} GS • DUT *****∫ I_G = 常量 Charge 图 13. 栅极电荷测试电路与波形 R VDS V_{DS} 90% ο V_{DD} V_{GS} R_{G} 10% V_{GS} DUT V_{GS} ∏ t, a 图 14. 阻性开关测试电路与波形 L $E_{AS} = \frac{1}{2} L I_{AS}^2$ VDS $\mathsf{BV}_{\mathsf{DSS}}$ 0 ID a I_{AS} R_{G} ∔v₀ I_D (t) V_{GS} [$V_{DS}(t)$ V_{DD} DUT Time t_p 图 15. 非箝位电感开关测试电路与波形

FCPF400N60 — N 沟道 SuperFET[®] II MOSFET







SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

	all such liaucinaiks.		
AccuPower TM AX-CAP [®] * BitSiC TM Build it Now TM CorePOWER TM CROSSVOL7 TM CTL TM CRUTH Transfer Logic TM DEUXPEED [®] Dual Cool TM EcoSPARK [®] EfficentMax TM ESBC TM Fairchild [®] Fairchild Semiconductor [®] FACT Quiet Series TM FACT [®] FAST [®] FastvCore TM	F-PFS TM FRFET [®] Global Power Resource SM Green FPS TM Green FPS TM e-Series TM Gmax TM GTO TM IntelliMAX TM ISOPLANAR TM Marking Small Speakers Sound Lou and Better TM MegaBuck TM MICROCOUPLER TM MicroPak TM Mi	Saving our world, 1mW/W/kW at a time™ Signal/Wise™ SmartMax™ Solutions for Your Success™ SPM [®] STEALTH™ SuperFET [®] SuperSOT™-3 SuperSOT™-6 SuperSOT™-8	Sync-Lock [™] EGENERAL TinyBoost [®] TinyBuck [®] TinyCalc [™] TinyLogic [®] TINYOPTO [™] TinyPOWer [™] TinyPWM [™] TinyPWM [™] TinyWire [™] TriFault Detect [™] TRUECURRENT [®] * µSerDes [™] UHC [®] Ultra FRFET [™] VCX [™] VisualMax [™]
FAST®	OptoHiT™		VCX™

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed Full Producti		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC